

**Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

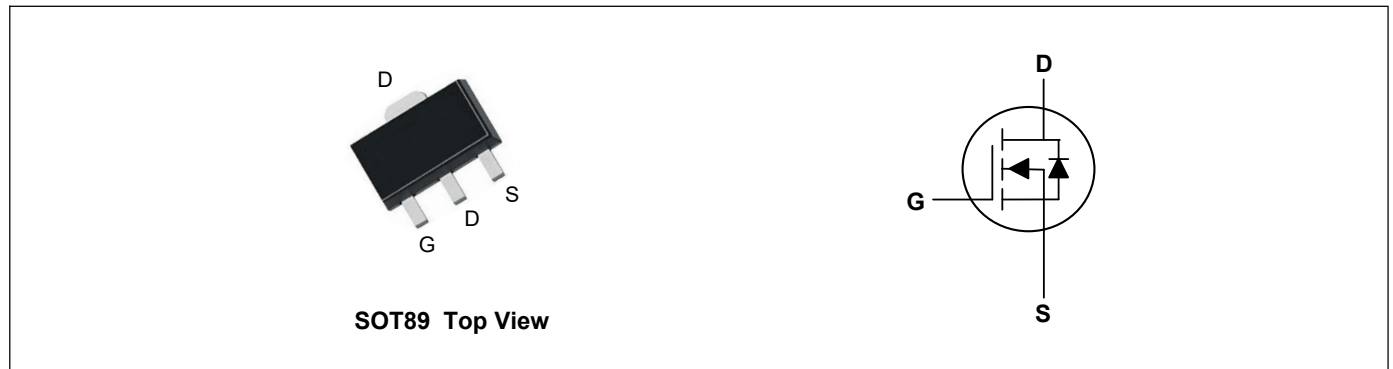
**Product Summary**



$V_{DS}$	60	V
$I_D$	5	A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	90	m $\Omega$
$R_{DS(ON)}$ (at $V_{GS}=4.5V$ )	100	m $\Omega$

**Applications**

- High Frequency Point-of-Load, Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch



**Absolute Maximum Ratings ( $T_C=25^{\circ}C$ , unless otherwise noted)**

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$I_D@T_C=25^{\circ}C$	5	A
Continuous Drain Current <sup>1</sup>	$I_D@T_C=100^{\circ}C$	2.2	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	16	A
Single Pulse Avalanche Energy <sup>3</sup>	$E_{AS}$	6.5	mJ
Total Power Dissipation <sup>4</sup>	$P_D$	2	W
Storage Temperature Range	$T_{STG}$	-55 to 150	$^{\circ}C$
Operating Junction Temperature Range	$T_J$	-55 to 150	$^{\circ}C$

**Thermal Characteristics**

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient <sup>1</sup>	$R_{\theta JA}$	---	85	$^{\circ}C/W$
Thermal Resistance Junction-Case <sup>1</sup>	$R_{\theta JC}$	---	24	$^{\circ}C/W$

**Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60	---	---	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2A	---	70	90	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =1A	---	80	100	mΩ
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	---	2.5	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	---	---	1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =48V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A	---	5.2	---	nC
Gate-Source Charge	Q <sub>gs</sub>		---	1.5	---	
Gate-Drain Charge	Q <sub>gd</sub>		---	2	---	
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> =30V, V <sub>GS</sub> =10V, R <sub>G</sub> =3.3Ω, I <sub>D</sub> =2A	---	3	---	ns
Rise Time	T <sub>r</sub>		---	6	---	
Turn-Off Delay Time	T <sub>d(off)</sub>		---	22	---	
Fall Time	T <sub>f</sub>		---	13	---	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz	---	510	---	pF
Output Capacitance	C <sub>oss</sub>		---	36	---	
Reverse Transfer Capacitance	C <sub>rss</sub>		---	25	---	

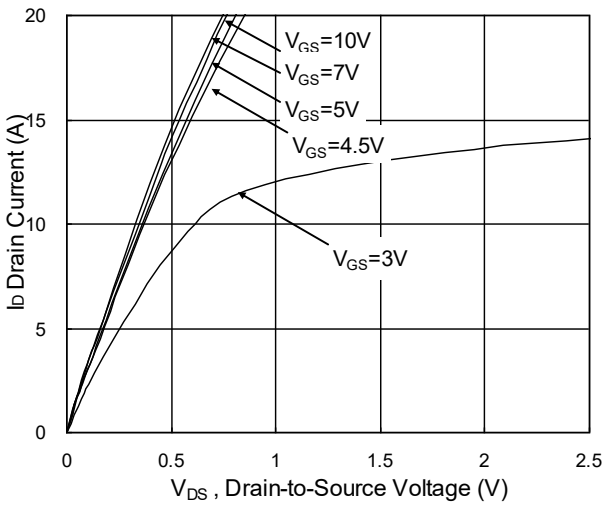
**Drain-Source Diode Characteristics**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode Forward Voltage <sup>2</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =2A, T <sub>J</sub> =25°C	---	0.8	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =2A, V <sub>R</sub> =0V di/dt=100A/μs, T <sub>J</sub> =25°C	---	9	---	nS
Reverse Recovery Charge	Q <sub>rr</sub>		---	6	---	nC

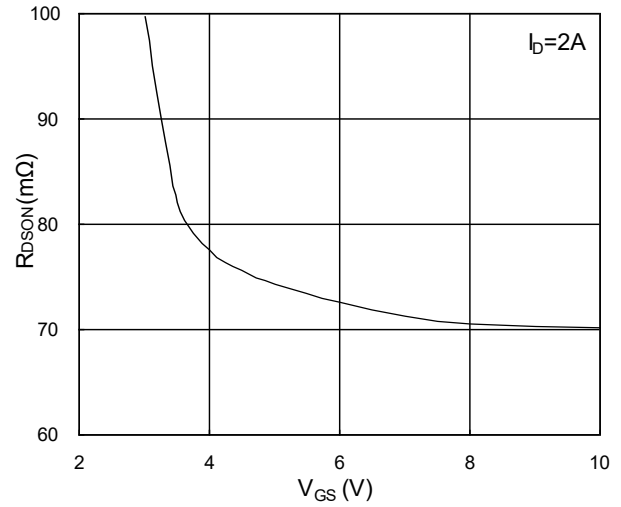
**Note:**

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=30V,L=0.1mH
- 4.The power dissipation is limited by 150°C junction temperature

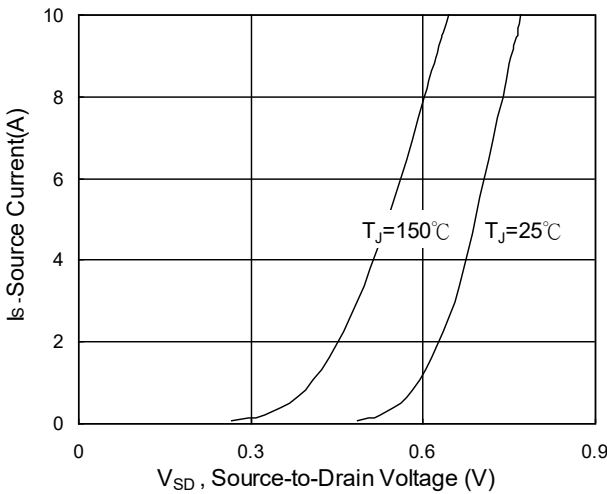
**Typical Characteristics**



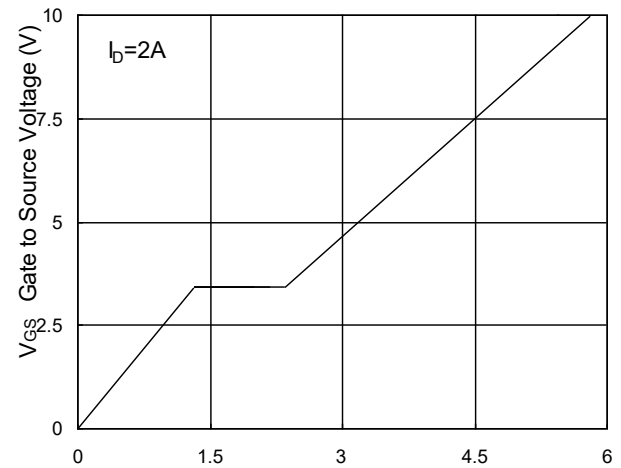
**Fig.1 Typical Output Characteristics**



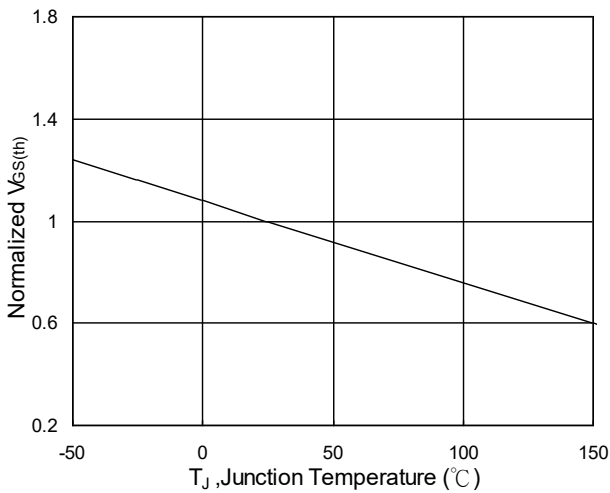
**Fig.2 On-Resistance vs. Gate-Source**



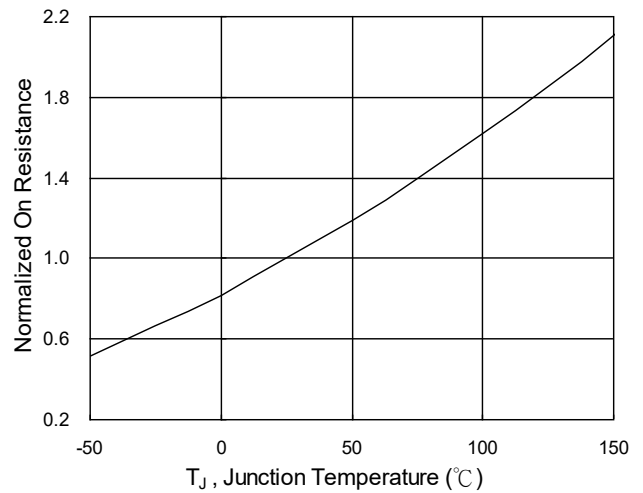
**Fig.3 Forward Characteristics Of Reverse**



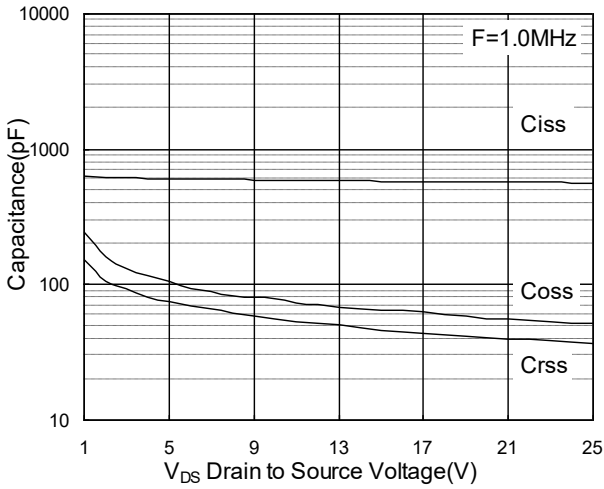
**Fig.4 Gate-Charge Characteristics**



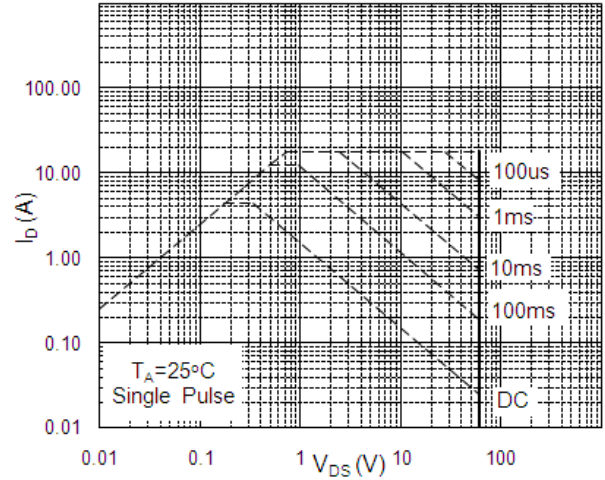
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



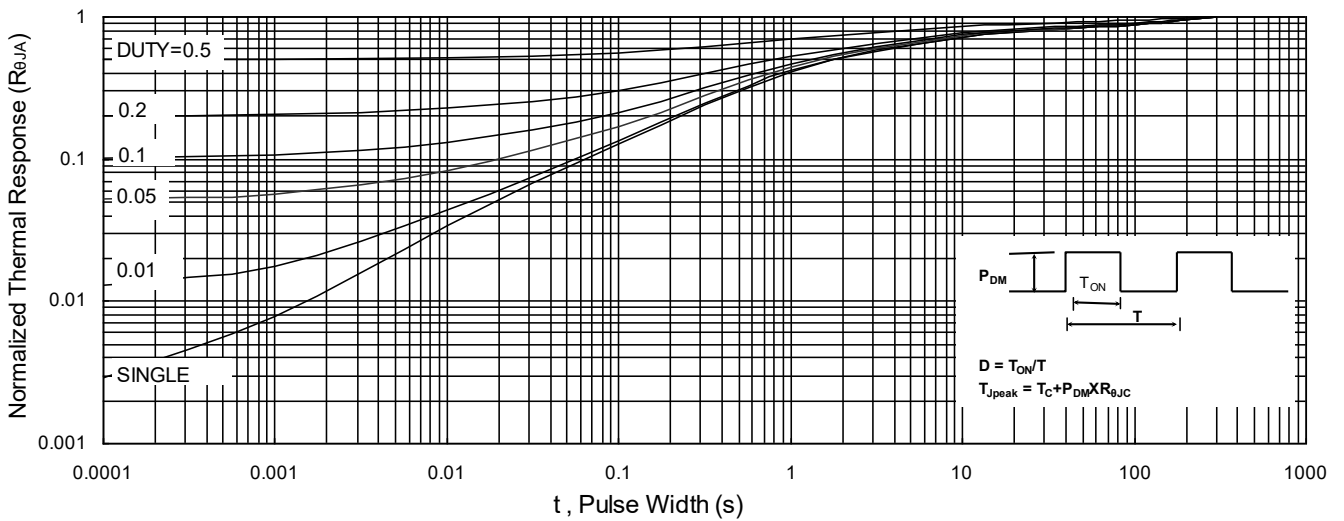
**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



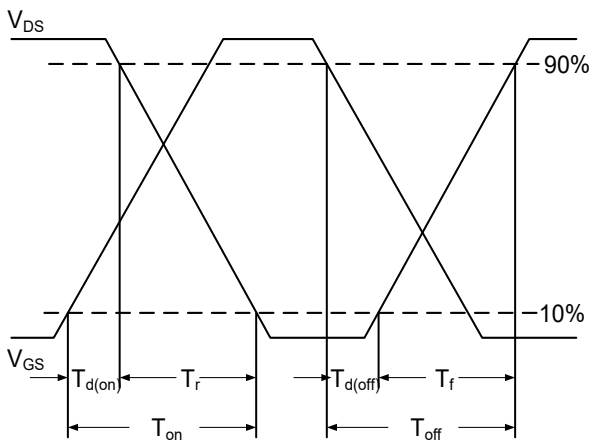
**Fig.7 Capacitance**



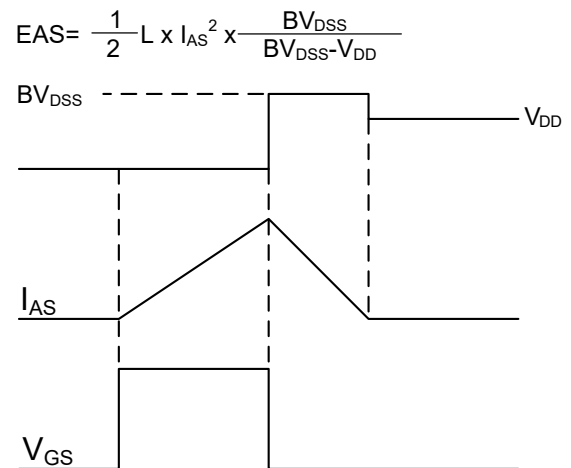
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**

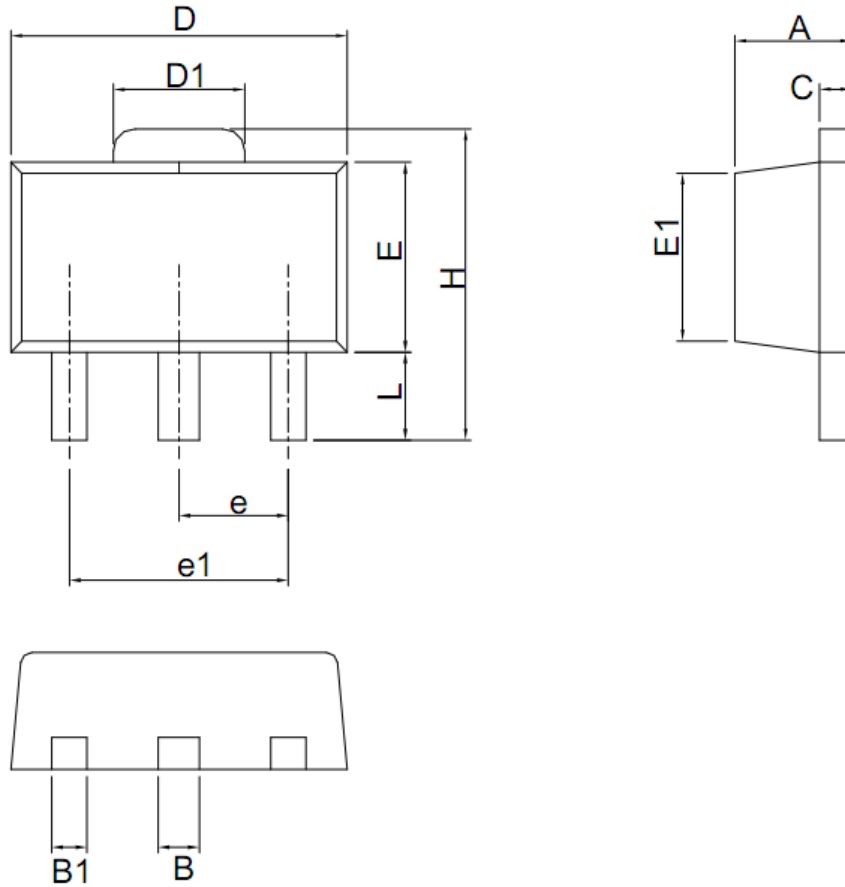


**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching Waveform**

**SOT89 Package Outline Dimensions**



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
<b>A</b>	1.40	1.50	1.60	<b>E</b>	2.40	2.50	2.60
<b>B</b>	0.40	0.50	0.56	<b>E1</b>	2.10	2.20	2.30
<b>B1</b>	0.32	0.40	0.50	<b>e</b>	1.50 BSC		
<b>C</b>	0.35	0.40	0.44	<b>e1</b>	3.00 BSC		
<b>D</b>	4.40	4.50	4.60	<b>H</b>	3.94	4.10	4.25
<b>D1</b>	1.40	1.60	1.80	<b>L</b>	0.85	1.00	1.20